



DEVICE TYPE:				SEMPAC, INC. Open-Pak™ Technologies www.sempac.com 568 E. WEDDELL DRIVE, SUITE 5 SUNNYVALE, CALIFORNIA 94089 PHONE: (408) 400-9002 FAX: (408) 400-9006					
CUSTOMER:			DIE SIZE:						
WIRE TYPE/ SIZE:			NO. OF WIRES:						
 THIRD ANGLE PROJECTION	REVISIONS					32 Lead 7mm x 7mm MLP Open-Pak Bonding Diagram			
	ECN NO.	DATE	DESCRIPTION	APPROVED					
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETER DO NOT SCALE DRAWING	10498	10/27/05	PRODUCTION RELEASE	D.BENANDO		SIZE	PART NO.	REV	
DRAWN BY W. GRIFFITTS	DATE	10/26/05	PACKAGE SIZE:	7.00mm x 7.00mm		A	MLP7X7-32-OP-01	3	
APP BY P. FLASKERUD	DATE	10/26/05	DIE PAD SIZE:	5.20mm x 5.20mm		SCALE 24X	CAD FILE	SHEET 1 OF 1	
						MLP7X7-32-OP-01-B-R3.DWG			